1449 (Modified)

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**Information Disclosure** Statement By Applicant Applicant: Visco et al.

(Use Several Sheets if Necessary)

Filing Date 10/14/03

Group 1745

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/GC/	Cl	Visco, et al., "Ionically Conductive Composites for Protection of Active Metal Anodes," PolyPlus Battery Company, Appln. No. 10/731,771, filed December 5, 2003, pages 1-43 [PLUSP027X1].				
Examiner	/Gregg Cantelmo/		Date Considered 04/09/2007			

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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